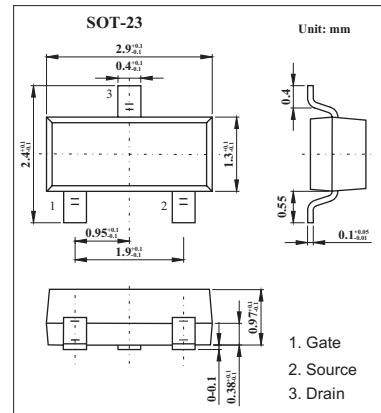
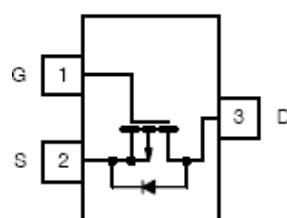


P-Channel 40-V (D-S) MOSFET

KI2319DS

■ Features

- TrenchFET Power MOSFET



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	5 sec	Steady State	Unit
Drain-Source Voltage	V _{DS}		-40	V
Gate-Source Voltage	V _{Gs}		±20	V
Continuous Drain Current (T _J =150°C) * 1 TA=25°C TA=70°C	I _D	-3.0 -2.4	-2.3 -1.85	A
Pulsed Drain Current *2	I _{DM}		-12	A
Continuous Source Current (diode conduction) *1	I _S	-1.0	-0.62	A
Power Dissipation *1 TA=25°C TA=70°C	P _D	1.25 0.8	0.75 0.48	W
Junction Temperature	T _j		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C

* 1 Surface Mounted on FR4 Board. t ≤ 5 sec.

*2 Pulse width limited by maximum junction temperature.

■ Thermal Resistance Ratings Ta = 25°C

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient *1	R _{thJA}	75	100	°C/W
Maximum Junction-to-Ambient *2 Steady State		120	166	
Maximum Junction-to-Foot (Drain) Steady State	R _{thJF}	40	50	

* 1. Surface Mounted on FR4 Board, t ≤ 5 sec.

* 2. Surface Mounted on FR4 Board.

KI2319DS■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-40			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-1.0		-3.0	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$			-10	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \leq -5 \text{ V}, V_{GS} = -10 \text{ V}$	-6			A
Drain-Source On-State Resistance *	$r_{DS(on)}$	$V_{GS} = -10 \text{ V}, I_D = -3.0 \text{ A}$		0.065	0.082	Ω
		$V_{GS} = -4.5 \text{ V}, I_D = -2.4 \text{ A}$		0.10	0.130	
Forward Transconductance *	g_{fs}	$V_{DS} = -5 \text{ V}, I_D = -3.0 \text{ A}$		7		S
Diode Forward Voltage *	V_{SD}	$I_S = -1.25 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V
Total Gate Charge	Q_g	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -3 \text{ A}$		11.3	17	nC
Gate-Source Charge	Q_{gs}			1.7		
Gate-Drain Charge	Q_{gd}			3.3		
Input Capacitance	C_{iss}	$V_{DS} = -20 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		470		pF
Output Capacitance	C_{oss}			85		
Reverse Transfer Capacitance	C_{rss}			65		
Turn-On Time	$t_{d(on)}$	$V_{DD} = -20 \text{ V}, R_L = 20 \Omega, I_D = -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_G = 6 \Omega$		7	15	ns
	t_r			15	25	
Turn-Off Time	$t_{d(off)}$			25	40	
	t_f			25	40	

* Pulse test: $PW \leq 300 \mu\text{s}$ duty cycle $\leq 2\%$.

■ Marking

Marking	C9
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